ADVANCED POWER TECHNOLOGY®

APT50M75JFLL

500V 52A 0.075 Ω

POWER MOS 7™

FREDFET

Power MOS 7^{TM} is a new generation of low loss, high voltage, N-Channel enhancement mode power MOSFETS. Both conduction and switching losses are addressed with Power MOS 7^{TM} by significantly lowering $R_{\text{DS(ON)}}$ and Q_g . Power MOS 7^{TM} combines lower conduction and switching losses along with exceptionally fast switching speeds inherent with APT's patented metal gate structure.

- Lower Input Capacitance
- Lower Miller Capacitance
- Lower Gate Charge, Qg
- Increased Power Dissipation
- Easier To Drive
- Popular SOT-227 Package
- FAST RECOVERY BODY DIODE





MAXIMUM RATINGS

All Ratings: $T_C = 25^{\circ}$ C unless otherwise specified.

| Symbol | Parameter | APT50M75JFLL | UNIT | |
|----------------------------------|---|--------------|-------|--|
| V _{DSS} | Drain-Source Voltage | 500 | Volts | |
| I _D | Continuous Drain Current @ T _C = 25°C | 52 | Amne | |
| I _{DM} | Pulsed Drain Current ① | 208 | Amps | |
| V _{GS} | Gate-Source Voltage Continuous | ±30 | Valta | |
| V _{GSM} | Gate-Source Voltage Transient | ±40G | Volts | |
| P _D | Total Power Dissipation @ T _C = 25°C | 480 | Watts | |
| , D | Linear Derating Factor | 3.84 | W/°C | |
| T _J ,T _{STG} | Operating and Storage Junction Temperature Range | -55 to 150 | °C | |
| T _L | Lead Temperature: 0.063" from Case for 10 Sec. | 300 | | |
| I _{AR} | Avalanche Current (Repetitive and Non-Repetitive) | 52 | Amps | |
| E _{AR} | Repetitive Avalanche Energy ① | 50 | m | |
| E _{AS} | Single Pulse Avalanche Energy ⁴ | 2500 | mJ | |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|--|-----|-----|-------|-------|
| BV _{DSS} | Drain-Source Breakdown Voltage (V _{GS} = 0V, I _D = 250μA) | 500 | | | Volts |
| I _{D(on)} | On State Drain Current ② $(V_{DS} > I_{D(on)} \times R_{DS(on)} Max, V_{GS} = 10V)$ | 52 | | | Amps |
| R _{DS(on)} | Drain-Source On-State Resistance ② (V _{GS} = 10V, 0.5 I _{D[Cont.]}) | | | 0.075 | Ohms |
| I _{DSS} | Zero Gate Voltage Drain Current (V _{DS} = V _{DSS} , V _{GS} = 0V) | | | 250 | μА |
| | Zero Gate Voltage Drain Current ($V_{DS} = 0.8 V_{DSS}$, $V_{GS} = 0V$, $T_{C} = 125$ °C) | | | 1000 | |
| I _{GSS} | Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$ | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 2.5 \text{mA})$ | 3 | | 5 | Volts |

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

USA

DYNAMIC CHARACTERISTICS

APT50M75JFLL

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|----------------------|--------------------------------|--|-----|------|-----|------|
| C _{iss} | Input Capacitance | V _{GS} = 0V | | 5400 | | |
| C _{oss} | Output Capacitance | $V_{DS} = 25V$ | | 1040 | | pF |
| C _{rss} | Reverse Transfer Capacitance | f = 1 MHz | | 95 | | |
| Qg | Total Gate Charge ^③ | V _{GS} = 10V | | 145 | | |
| Q_{gs} | Gate-Source Charge | $V_{DD} = 0.5 V_{DSS}$ | | 30 | | nC |
| Q_{gd} | Gate-Drain ("Miller") Charge | I _D = I _D [Cont.] @ 25°C | | 70 | | |
| t _d (on) | Turn-on Delay Time | V _{GS} = 15V | | 11 | | |
| t _r | Rise Time | $V_{DD} = 0.5 V_{DSS}$ | | 12 | | ns |
| t _d (off) | Turn-off Delay Time | $I_D = I_D [Cont.] @ 25°C$ | | 30 | | 115 |
| t _f | Fall Time | $R_G = 0.6\Omega$ | | 6 | | |

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | | MIN | TYP | MAX | UNIT |
|-------------------|--|------------------------|-----|-----|-----|-------|
| I _S | Continuous Source Current (Body Diode) | | | | 52 | A |
| I _{SM} | Pulsed Source Current (Body Diode) | | | | 208 | Amps |
| V _{SD} | Diode Forward Voltage (V _{GS} = 0V, I _S = -I _D [Cont.]) | | | | 1.3 | Volts |
| dv/ _{dt} | Peak Diode Recovery dv/dt (5) | | | | 5 | V/ns |
| | Reverse Recovery Time | T _j = 25°C | | | 250 | no |
| t _{rr} | $(I_S = -I_D [Cont.], \frac{di}{dt} = 100A/\mu s)$ | T _j = 125°C | | | 500 | ns |
| | Reverse Recovery Charge | T _j = 25°C | | 1.6 | | |
| Q_{rr} | $(I_S = -I_D [Cont.], \frac{di}{dt} = 100A/\mu s)$ | T _j = 125°C | | 5.5 | | μC |
| I _{RRM} | Peak Recovery Current | T _j = 25°C | | 15 | | A |
| | $(I_S = -I_D [Cont.], di/_{dt} = 100A/\mu s)$ | T _j = 125°C | | 27 | | Amps |

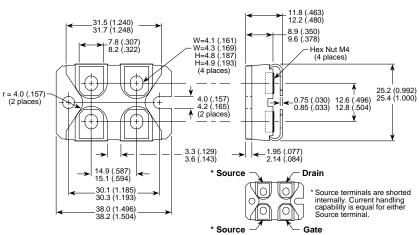
THERMAL CHARACTERISTICS

| Symbol | Characteristic | MIN | TYP | MAX | UNIT |
|-----------------|---------------------|-----|-----|------|------|
| $R_{	heta JC}$ | Junction to Case | | | 0.26 | |
| $R_{\theta JA}$ | Junction to Ambient | | | 40 | °C/W |

① Repetitive Rating: Pulse width limited by maximum junction temperature.

APT Reserves the right to change, without notice, the specifications and information contained herein.

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

³ See MIL-STD-750 Method 3471

⁴ Starting $T_i = +25$ °C, L = 1.85mH, $R_G = 25\Omega$, Peak $I_L = 52$ A

② Pulse Test: Pulse width < 380 μS, Duty Cycle < 2%